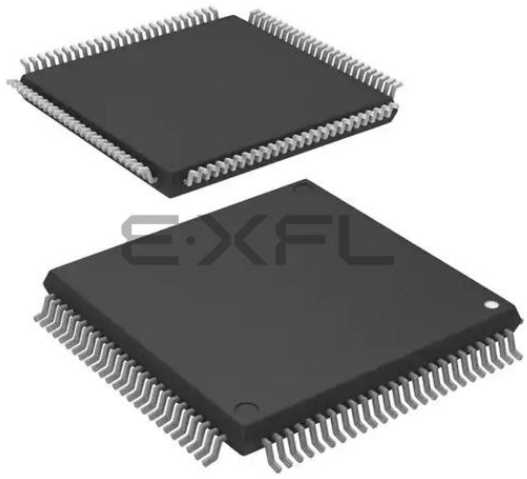
Renesas Electronics America Inc - R5F563TCEDFP#V0 Datasheet



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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	EBI/EMI, I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	57
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 12x10b, 8x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f563tcedfp-v0

1. Overview

1.1 Outline of Specifications

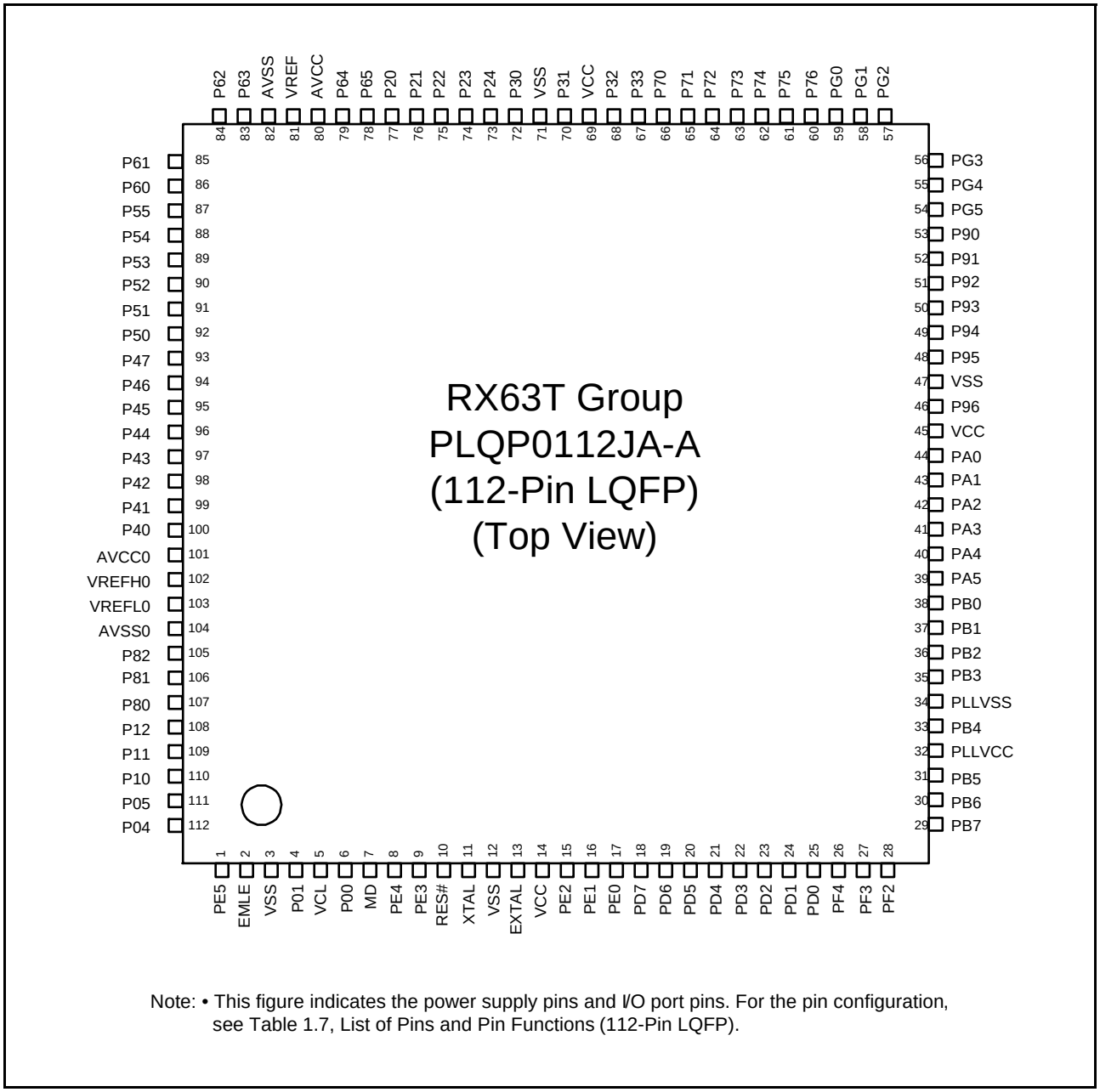
Table 1.1 lists the specifications in outline, and Table 1.2 lists the functions of products.
Table 1.1 shows an outline of the maximum specifications, and the available peripheral modules and number of channels differ according to the number of pins on the package and the ROM capacity. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/7)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 100 MHz • 32-bit RX CPU • Minimum instruction execution time: One instruction per state (cycle of the system clock) • Address space: 4-Gbyte linear • Register set of the CPU General purpose: Sixteen 32-bit registers Control: Nine 32-bit registers Accumulator: One 64-bit register • Basic instructions: 73 • Floating-point operation instructions: 8 • DSP instructions: 9 • Addressing modes: 10 • Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32 × 32 → 64 bits • On-chip divider: 32 / 32 → 32 bits • Barrel shifter: 32 bits • Memory protection unit (MPU)
	FPU	• Single precision floating point (32 bits) • Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	• Capacity: 512 Kbytes, 384 Kbytes, 256 Kbytes, 64 Kbytes, 48 Kbytes, 32 Kbytes • 100 MHz, no-wait access • On-board programming: Programs can be modified through SCI or USB while the MCU is mounted on the board. • Off-board programming: Programs can be modified using parallel programmer. (only in 144-, 120-, 112- and 100-pin versions)
	RAM	• Capacity: 48 Kbytes, 32 Kbytes, 24 Kbytes, 8 Kbytes • 100 MHz, no-wait access
	E^2 data flash	• Capacity: 32 Kbytes, 8 Kbytes • Programming/erasing: 100,000 times • On-board programming: Programs can be modified through SCI or USB while the MCU is mounted on the board. Programming from the user program is possible.
MCU operating modes		[144-, 120-, 112- and 100-pin versions] Single-chip mode, on-chip ROM enabled extended mode, on-chip ROM disabled extended mode (switchable by software) [64- and 48-pin versions] Single-chip mode

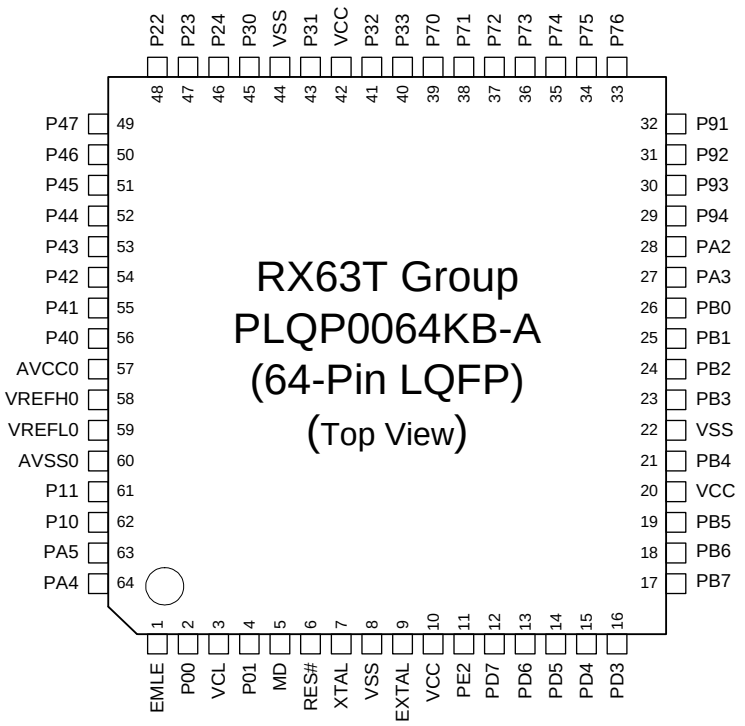
Table 1.1 Outline of Specifications (6/7)

Classification Module/Function	Description
12-bit A/D converter (S12ADB) [64- and 48-pin versions]	• 12 bits (8 channels x 1 unit) • 12-bit resolution • Conversion time 1.0 µs per channel (S12ADB clock: PCLKD (A/D conversion clock: ADCLK) = 50 MHz • Operating modes Scan mode (single scan mode / continuous scan mode / group scan mode) Group A priority control (group scan mode only) • Sample-and-hold function A common sample-and-hold circuit for units is included Separate sample-and-hold circuits are also included (three channels per unit) • Self-diagnosis function Three analog input voltages (VREFL0, VREFH0 × 1/2, VREFH0) can be generated internally by the self-diagnosis function. • Double trigger mode (double the results of A/D conversion) • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. • Window comparators (three channels per unit)
10-bit A/D converter (ADA)	10 bits (20 channels × 1 unit) • 10-bit resolution • Conversion time 0.5 µs per channel (A/D conversion clock ADCLK = 100 MHz) • Two operating modes Single mode, scan mode • Scan mode Single-cycle scan mode Continuous scan mode • Sample-and-hold function A common sample-and-hold circuit for units is included • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. • 8-bit precision output 2-bit right shifting for output of conversion results is selectable. • Self-diagnostic function The self-diagnostic function internally generates three analog input voltages (AVSS, VREF x 1/2, VREF)
D/A converter (DAa)	• 2 channels • 10-bit resolution • Output voltage: 0 V to VREF
CRC calculator (CRC)	• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$. • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable
Data operating circuit (DOC)	• Comparison, addition, and subtraction of 16-bit data
Digital power supply controller (DPC)	• Control parameters calculation unit of the digital switch-mode power supply systems. • Adopt robust control algorithm with high control stability • Results of measurement by the 10-bit A/D converter can be used in calculating the control parameters.
Operating frequency	Up to 100 MHz
Power supply voltage [144-, 120-, 112- and 100-pin versions]	• 3-V product VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V AVCC0 = AVCC = VREF = 3.0 to 3.6 V, or 4.0 to 5.5 V VREFH0 = 3.0 to AVCC0, or 4.0 to AVCC0 • 5-V product VCC = PLLVCC = 4.0 to 5.5 V VCC_USB = 3.0 to 3.6 V AVCC0 = AVCC = VREF = 4.0 to 5.5 V VREFH0 = 4.0 to AVCC0
Power supply voltage [64- and 48-pin versions]	VCC = 2.7 to 3.6 V, AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0



Note: • This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.7, List of Pins and Pin Functions (112-Pin LQFP).

Figure 1.5 Pin Assignment (112-Pin LQFP)



Note: • This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.9, List of Pins and Pin Functions (64-Pin LQFP).

Figure 1.7 Pin Assignment (64-Pin LQFP)

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

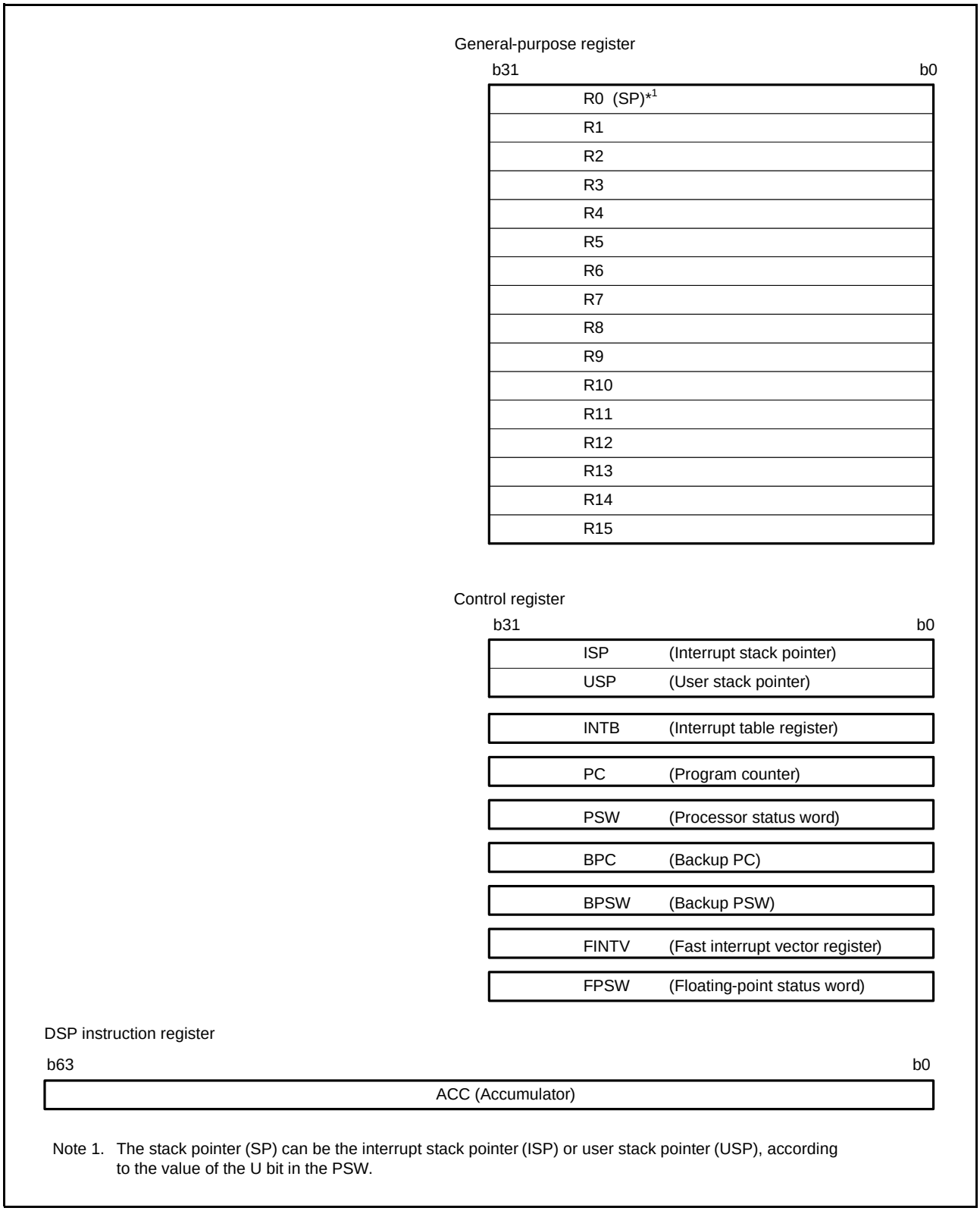


Figure 2.1 Register Set of the CPU

4. I/O Registers

This section gives information on the on-chip I/O register addresses. The information is given as shown below. Notes on writing to registers are also given at the end.

(1) I/O register addresses (address order)

- Registers are listed from the lower allocation addresses.
- Registers are classified according to module symbols.
- The number of access cycles indicates the number of cycles based on the specified reference clock.
- Among the internal I/O register area, addresses not listed in the list of registers are reserved. Reserved addresses must not be accessed. Do not access these addresses; otherwise, the operation when accessing these bits and subsequent operations cannot be guaranteed.

(2) Notes on writing to I/O registers

When writing to an I/O register, the CPU starts executing the subsequent instruction before completing I/O register write. This may cause the subsequent instruction to be executed before the post-update I/O register value is reflected on the operation.
As described in the following examples, special care is required for the cases in which the subsequent instruction must be executed after the post-update I/O register value is actually reflected.

[Examples of cases requiring special care]

- The subsequent instruction must be executed while an interrupt request is disabled with the IENj bit in IERn of the ICU (interrupt request enable bit) cleared to 0.
- A WAIT instruction is executed immediately after the preprocessing for causing a transition to the low power consumption state.

In the above cases, after writing to an I/O register, wait until the write operation is completed using the following procedure and then execute the subsequent instruction.

(a) Write to an I/O register.
(b) Read the value from the I/O register to a general register.
(c) Execute the operation using the value read.
(d) Execute the subsequent instruction.

[Instruction examples]

- Byte-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.B  #SFR_DATA, [R1]
CMP    [R1].UB, R1
;; Next process
```

- Word-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.W  #SFR_DATA, [R1]
CMP    [R1].W, R1
;; Next process
```

Table 4.1 List of I/O Registers (Address Order) (7/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 70C0h	ICU	Interrupt Request Register 192	IR192	8	8	2 ICLK		ICUb	Not present in versions with 112, 100, 64 or 48 pins.
0008 70C1h	ICU	Interrupt Request Register 193	IR193	8	8	2 ICLK			Not present in versions with 112, 100, 64 or 48 pins.
0008 70C2h	ICU	Interrupt Request Register 194	IR194	8	8	2 ICLK			
0008 70C3h	ICU	Interrupt Request Register 195	IR195	8	8	2 ICLK			
0008 70C4h	ICU	Interrupt Request Register 196	IR196	8	8	2 ICLK			
0008 70C5h	ICU	Interrupt Request Register 197	IR197	8	8	2 ICLK			
0008 70C6h	ICU	Interrupt Request Register 198	IR198	8	8	2 ICLK			
0008 70C7h	ICU	Interrupt Request Register 199	IR199	8	8	2 ICLK			
0008 70C8h	ICU	Interrupt Request Register 200	IR200	8	8	2 ICLK			
0008 70C9h	ICU	Interrupt Request Register 201	IR201	8	8	2 ICLK			
0008 70D6h	ICU	Interrupt Request Register 214	IR214	8	8	2 ICLK			
0008 70D7h	ICU	Interrupt Request Register 215	IR215	8	8	2 ICLK			
0008 70D8h	ICU	Interrupt Request Register 216	IR216	8	8	2 ICLK			
0008 70D9h	ICU	Interrupt Request Register 217	IR217	8	8	2 ICLK			
0008 70DAh	ICU	Interrupt Request Register 218	IR218	8	8	2 ICLK			
0008 70DBh	ICU	Interrupt Request Register 219	IR219	8	8	2 ICLK			
0008 70DCh	ICU	Interrupt Request Register 220	IR220	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 70DDh	ICU	Interrupt Request Register 221	IR221	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 70DEh	ICU	Interrupt Request Register 222	IR222	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 70DFh	ICU	Interrupt Request Register 223	IR223	8	8	2 ICLK			Not present in versions with 100, 64 or 48 pins.
0008 70E0h	ICU	Interrupt Request Register 224	IR224	8	8	2 ICLK			Not present in versions with 100, 64 or 48 pins.
0008 70E1h	ICU	Interrupt Request Register 225	IR225	8	8	2 ICLK			Not present in versions with 100, 64 or 48 pins.
0008 70E2h	ICU	Interrupt Request Register 226	IR226	8	8	2 ICLK			
0008 70E3h	ICU	Interrupt Request Register 227	IR227	8	8	2 ICLK			
0008 70E4h	ICU	Interrupt Request Register 228	IR228	8	8	2 ICLK			
0008 70E5h	ICU	Interrupt Request Register 229	IR229	8	8	2 ICLK			
0008 70E6h	ICU	Interrupt Request Register 230	IR230	8	8	2 ICLK			
0008 70E7h	ICU	Interrupt Request Register 231	IR231	8	8	2 ICLK			
0008 70E8h	ICU	Interrupt Request Register 232	IR232	8	8	2 ICLK			
0008 70E9h	ICU	Interrupt Request Register 233	IR233	8	8	2 ICLK			
0008 70EAh	ICU	Interrupt Request Register 234	IR234	8	8	2 ICLK			
0008 70EBh	ICU	Interrupt Request Register 235	IR235	8	8	2 ICLK			
0008 70ECh	ICU	Interrupt Request Register 236	IR236	8	8	2 ICLK			
0008 70EEh	ICU	Interrupt Request Register 238	IR238	8	8	2 ICLK			
0008 70EFh	ICU	Interrupt Request Register 239	IR239	8	8	2 ICLK			
0008 70F0h	ICU	Interrupt Request Register 240	IR240	8	8	2 ICLK			
0008 70F1h	ICU	Interrupt Request Register 241	IR241	8	8	2 ICLK			
0008 70F2h	ICU	Interrupt Request Register 242	IR242	8	8	2 ICLK			
0008 70F4h	ICU	Interrupt Request Register 244	IR244	8	8	2 ICLK			
0008 70F5h	ICU	Interrupt Request Register 245	IR245	8	8	2 ICLK			
0008 70F6h	ICU	Interrupt Request Register 246	IR246	8	8	2 ICLK			
0008 70F7h	ICU	Interrupt Request Register 247	IR247	8	8	2 ICLK			
0008 70F8h	ICU	Interrupt Request Register 248	IR248	8	8	2 ICLK			
0008 70FAh	ICU	Interrupt Request Register 250	IR250	8	8	2 ICLK			
0008 70FBh	ICU	Interrupt Request Register 251	IR251	8	8	2 ICLK			
0008 70FCh	ICU	Interrupt Request Register 252	IR252	8	8	2 ICLK			

Table 4.1 List of I/O Registers (Address Order) (10/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 71BBh	ICU	DTC Activation Enable Register 187	DTCER187	8	8	2 ICLK		ICUb	Not present in versions with 64 or 48 pins.
0008 71BCh	ICU	DTC Activation Enable Register 188	DTCER188	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 71BDh	ICU	DTC Activation Enable Register 189	DTCER189	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 71BFh	ICU	DTC Activation Enable Register 191	DTCER191	8	8	2 ICLK			Not present in versions with 112, 100, 64 or 48 pins.
0008 71C0h	ICU	DTC Activation Enable Register 192	DTCER192	8	8	2 ICLK			Not present in versions with 112, 100, 64 or 48 pins.
0008 71C3h	ICU	DTC Activation Enable Register 195	DTCER195	8	8	2 ICLK			
0008 71C4h	ICU	DTC Activation Enable Register 196	DTCER196	8	8	2 ICLK			
0008 71C6h	ICU	DTC Activation Enable Register 198	DTCER198	8	8	2 ICLK			
0008 71C7h	ICU	DTC Activation Enable Register 199	DTCER199	8	8	2 ICLK			
0008 71C8h	ICU	DTC Activation Enable Register 200	DTCER200	8	8	2 ICLK			
0008 71C9h	ICU	DTC Activation Enable Register 201	DTCER201	8	8	2 ICLK			
0008 71D6h	ICU	DTC Activation Enable Register 214	DTCER214	8	8	2 ICLK			
0008 71D7h	ICU	DTC Activation Enable Register 215	DTCER215	8	8	2 ICLK			
0008 71D9h	ICU	DTC Activation Enable Register 217	DTCER217	8	8	2 ICLK			
0008 71DAh	ICU	DTC Activation Enable Register 218	DTCER218	8	8	2 ICLK			
0008 71DCh	ICU	DTC Activation Enable Register 220	DTCER220	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 71DDh	ICU	DTC Activation Enable Register 221	DTCER221	8	8	2 ICLK			Not present in versions with 64 or 48 pins.
0008 71DFh	ICU	DTC Activation Enable Register 223	DTCER223	8	8	2 ICLK			Not present in versions with 100, 64 or 48 pins.
0008 71E0h	ICU	DTC Activation Enable Register 224	DTCER224	8	8	2 ICLK			Not present in versions with 100, 64 or 48 pins.
0008 71E2h	ICU	DTC Activation Enable Register 226	DTCER226	8	8	2 ICLK			
0008 71E3h	ICU	DTC Activation Enable Register 227	DTCER227	8	8	2 ICLK			
0008 71E4h	ICU	DTC Activation Enable Register 228	DTCER228	8	8	2 ICLK			
0008 71E5h	ICU	DTC Activation Enable Register 229	DTCER229	8	8	2 ICLK			
0008 71E6h	ICU	DTC Activation Enable Register 230	DTCER230	8	8	2 ICLK			
0008 71E7h	ICU	DTC Activation Enable Register 231	DTCER231	8	8	2 ICLK			
0008 71E8h	ICU	DTC Activation Enable Register 232	DTCER232	8	8	2 ICLK			
0008 71E9h	ICU	DTC Activation Enable Register 233	DTCER233	8	8	2 ICLK			
0008 71EAh	ICU	DTC Activation Enable Register 234	DTCER234	8	8	2 ICLK			
0008 71EBh	ICU	DTC Activation Enable Register 235	DTCER235	8	8	2 ICLK			
0008 71ECh	ICU	DTC Activation Enable Register 236	DTCER236	8	8	2 ICLK			
0008 71EEh	ICU	DTC Activation Enable Register 238	DTCER238	8	8	2 ICLK			
0008 71EFh	ICU	DTC Activation Enable Register 239	DTCER239	8	8	2 ICLK			
0008 71F0h	ICU	DTC Activation Enable Register 240	DTCER240	8	8	2 ICLK			
0008 71F1h	ICU	DTC Activation Enable Register 241	DTCER241	8	8	2 ICLK			
0008 71F2h	ICU	DTC Activation Enable Register 242	DTCER242	8	8	2 ICLK			
0008 71F4h	ICU	DTC Activation Enable Register 244	DTCER244	8	8	2 ICLK			
0008 71F5h	ICU	DTC Activation Enable Register 245	DTCER245	8	8	2 ICLK			
0008 71F6h	ICU	DTC Activation Enable Register 246	DTCER246	8	8	2 ICLK			
0008 71F7h	ICU	DTC Activation Enable Register 247	DTCER247	8	8	2 ICLK			
0008 71F8h	ICU	DTC Activation Enable Register 248	DTCER248	8	8	2 ICLK			
0008 71FAh	ICU	DTC Activation Enable Register 250	DTCER250	8	8	2 ICLK			
0008 71FBh	ICU	DTC Activation Enable Register 251	DTCER251	8	8	2 ICLK			
0008 7202h	ICU	Interrupt Request Enable Register 02	IER02	8	8	2 ICLK			
0008 7203h	ICU	Interrupt Request Enable Register 03	IER03	8	8	2 ICLK			
0008 7204h	ICU	Interrupt Request Enable Register 04	IER04	8	8	2 ICLK			
0008 7205h	ICU	Interrupt Request Enable Register 05	IER05	8	8	2 ICLK			

Table 4.1 List of I/O Registers (Address Order) (16/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 8330h	RIIC1	I²C Bus Bit Rate Low-Level Register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	RIIC	Not present in versions with 112, 100, 64, or 48 pins.
0008 8331h	RIIC1	I²C Bus Bit Rate High-Level Register	ICBRH	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8332h	RIIC1	I²C Bus Transmit Data Register	ICDRT	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8333h	RIIC1	I²C Bus Receive Data Register	ICDRR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8380h	RSPI0	RSPI Control Register	SPCR	8	8	2, 3 PCLKB	2 ICLK	RSPI	
0008 8381h	RSPI0	RSPI Slave Select Polarity Register	SSLP	8	8	2, 3 PCLKB	2 ICLK		
0008 8382h	RSPI0	RSPI Pin Control Register	SPPCR	8	8	2, 3 PCLKB	2 ICLK		
0008 8383h	RSPI0	RSPI Status Register	SPSR	8	8	2, 3 PCLKB	2 ICLK		
0008 8384h	RSPI0	RSPI Data Register	SPDR	32	16, 32	2, 3 PCLKB	2 ICLK		
0008 8388h	RSPI0	RSPI Sequence Control Register	SPSCR	8	8	2, 3 PCLKB	2 ICLK		
0008 8389h	RSPI0	RSPI Sequence Status Register	SPSSR	8	8	2, 3 PCLKB	2 ICLK		
0008 838Ah	RSPI0	RSPI Bit Rate Register	SPBR	8	8	2, 3 PCLKB	2 ICLK		
0008 838Bh	RSPI0	RSPI Data Control Register	SPDCR	8	8	2, 3 PCLKB	2 ICLK		
0008 838Ch	RSPI0	RSPI Clock Delay Register	SPCKD	8	8	2, 3 PCLKB	2 ICLK		
0008 838Dh	RSPI0	RSPI Slave Select Negation Delay Register	SSLND	8	8	2, 3 PCLKB	2 ICLK		
0008 838Eh	RSPI0	RSPI Next-Access Delay Register	SPND	8	8	2, 3 PCLKB	2 ICLK		
0008 838Fh	RSPI0	RSPI Control Register 2	SPCR2	8	8	2, 3 PCLKB	2 ICLK		
0008 8390h	RSPI0	RSPI Command Register 0	SPCMD0	16	16	2, 3 PCLKB	2 ICLK		
0008 8392h	RSPI0	RSPI Command Register 1	SPCMD1	16	16	2, 3 PCLKB	2 ICLK		
0008 8394h	RSPI0	RSPI Command Register 2	SPCMD2	16	16	2, 3 PCLKB	2 ICLK		
0008 8396h	RSPI0	RSPI Command Register 3	SPCMD3	16	16	2, 3 PCLKB	2 ICLK		
0008 8398h	RSPI0	RSPI Command Register 4	SPCMD4	16	16	2, 3 PCLKB	2 ICLK		
0008 839Ah	RSPI0	RSPI Command Register 5	SPCMD5	16	16	2, 3 PCLKB	2 ICLK		
0008 839Ch	RSPI0	RSPI Command Register 6	SPCMD6	16	16	2, 3 PCLKB	2 ICLK		
0008 839Eh	RSPI0	RSPI Command Register 7	SPCMD7	16	16	2, 3 PCLKB	2 ICLK		
0008 83A0h	RSPI1	RSPI Control Register	SPCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A1h	RSPI1	RSPI Slave Select Polarity Register	SSLP	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A2h	RSPI1	RSPI Pin Control Register	SPPCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A3h	RSPI1	RSPI Status Register	SPSR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A4h	RSPI1	RSPI Data Register	SPDR	32	16, 32	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A8h	RSPI1	RSPI Sequence Control Register	SPSCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83A9h	RSPI1	RSPI Sequence Status Register	SPSSR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83AAh	RSPI1	RSPI Bit Rate Register	SPBR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83ABh	RSPI1	RSPI Data Control Register	SPDCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83ACh	RSPI1	RSPI Clock Delay Register	SPCKD	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83ADh	RSPI1	RSPI Slave Select Negation Delay Register	SSLND	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83AEh	RSPI1	RSPI Next-Access Delay Register	SPND	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83AFh	RSPI1	RSPI Control Register 2	SPCR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 83B0h	RSPI1	RSPI Command Register 0	SPCMD0	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (19/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 9804h	AD	A/D Channel Select Register 0	ADANSA0	16	16	2, 3 PCLKB	2 ICLK	AD	Not present in versions with 64 or 48 pins.
0008 9806h	AD	A/D Channel Select Register 1	ADANSA1	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64 or 48 pins.
0008 9808h	AD	A/D-Converted Value Addition Mode Select Register0	ADADS0	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 980Ah	AD	A/D-Converted Value Addition Mode Select Register1	ADADS1	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64 or 48 pins.
0008 980Ch	AD	A/D-Converted Value Addition Count Select Register	ADADC	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 980Eh	AD	A/D Control Extended Register	ADCER	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9810h	AD	A/D Start Trigger Select Register	ADSTRGR	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 981Eh	AD	A/D Self-Diagnosis Data Register	ADRD	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9820h	AD	A/D Data Register A	ADDRA	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9822h	AD	A/D Data Register B	ADDRB	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9824h	AD	A/D Data Register C	ADDRC	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9826h	AD	A/D Data Register D	ADDRD	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9828h	AD	A/D Data Register E	ADDRE	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 982Ah	AD	A/D Data Register F	ADDRF	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 982Ch	AD	A/D Data Register G	ADDRG	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 982Eh	AD	A/D Data Register H	ADDRH	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9830h	AD	A/D Data Register I	ADDRI	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9832h	AD	A/D Data Register J	ADDRJ	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9834h	AD	A/D Data Register K	ADDRK	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9836h	AD	A/D Data Register L	ADDRL	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9838h	AD	A/D Data Register M	ADDRM	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 983Ah	AD	A/D Data Register N	ADDRN	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 983Ch	AD	A/D Data Register O	ADDRO	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 983Eh	AD	A/D Data Register P	ADDRP	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 9840h	AD	A/D Data Register Q	ADDRQ	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 9842h	AD	A/D Data Register R	ADDRR	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 9844h	AD	A/D Data Register S	ADDRS	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 9846h	AD	A/D Data Register T	ADDRT	16	16	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 9860h	AD	A/D Sampling State Register 0	ADSSTR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9861h	AD	A/D Sampling State Register L	ADSSTRL	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (32/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
000A 006Ch	USB0	Pipe Maximum Packet Size Register	PIPEMAXP	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1	USBa	Not present in versions with 112, 100, 64, or 48 pins.
000A 006Eh	USB0	Pipe Cycle Control Register	PIPEPERI	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0070h	USB0	PIPE1 Control Register	PIPE1CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0072h	USB0	PIPE2 Control Register	PIPE2CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0074h	USB0	PIPE3 Control Register	PIPE3CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0076h	USB0	PIPE4 Control Register	PIPE4CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0078h	USB0	PIPE5 Control Register	PIPE5CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Ah	USB0	PIPE6 Control Register	PIPE6CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Ch	USB0	PIPE7 Control Register	PIPE7CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Eh	USB0	PIPE8 Control Register	PIPE8CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0080h	USB0	PIPE9 Control Register	PIPE9CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0090h	USB0	PIPE1 Transaction Counter Enable Register	PIPE1TRE	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.

5.3.3 Timing of Recovery from Low Power Consumption Modes

Table 5.10 Timing of Recovery from Low Power Consumption Modes

Note: Common standard values for conditions not given in the table are listed as “Condition 1” to “Condition 3” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

Condition 2: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

$T_a = T_{opr}$. T_a is common to conditions 1 to 3.

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time after cancellation of software standby mode	Crystal resonator connected to main clock oscillator	Main clock oscillator operating	t_{SBYMC}	10	—	—	ms	Figure 5.9
		Main clock oscillator and PLL circuit operating	t_{SBYPC}	10	—	—	ms	
	External clock input to main clock oscillator	Main clock oscillator operating	t_{SBYEX}	1	—	—	ms	
		Main clock oscillator and PLL circuit operating	t_{SBYPE}	1	—	—	ms	
	Low-speed clock oscillator or IWDT-specific low-speed clock oscillator operating		t_{SBYLO}	—	—	800	µs	
Recovery time after cancellation of deep software standby mode			t_{DSBY}	—	—	1	ms	Figure 5.10
Wait time after cancellation of deep software standby mode			t_{DSBYWT}	45	—	46	t_{cyc}	

Note: • The wait time varies depending on the state in which each oscillator was when the WAIT instruction was executed. The recovery time when multiple oscillators are operating is the same period as that when the oscillator, which takes the longest time for recovery among the operating oscillators, is operating alone.

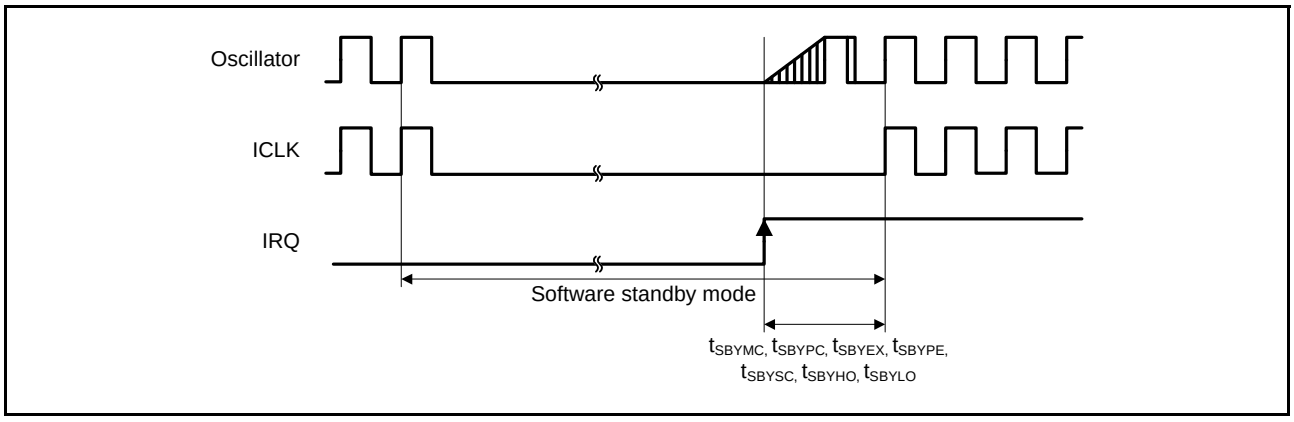


Figure 5.9 Software Standby Mode Cancellation Timing

Table 5.21 12-Bit A/D Conversion Characteristics (1)

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

$T_a = T_{opr}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		12	12	12	Bit	
Conversion time*1 (ADCLK = 25 MHz)	Without 0.1-µF external capacitor Permissible signal source impedance (max.) = 1.0 kΩ	2.0	—	—	µs	Sampling in 20 states
Analog input capacitance		—	—	8	pF	
Sample and hold circuit in use	Integral nonlinearity error	—	—	±4.0	LSB	AVin = 0.25 to AV_{REFH}–0.25
	Offset error	—	—	±4.0	LSB	
	Full-scale error	—	—	±4.0	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	—	±8.0	LSB	
Sample and hold circuit not in use	Integral nonlinearity error	—	—	±3.0	LSB	AVin = AV_{REFL} to AV_{REFH}
	Offset error	—	—	±3.0	LSB	
	Full-scale error	—	—	±3.0	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	—	±6.0	LSB	

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 5.22 12-Bit A/D Conversion Characteristics (2)

Note: Common standard values for conditions not given in the table are listed as “Condition 1” and “Condition 2” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 2: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

$T_a = T_{opr}$. T_a is common to conditions 2 and 3.

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		12	12	12	Bit	
Conversion time*1 (ADCLK = 50 MHz)	Without 0.1-µF external capacitor Permissible signal source impedance (max.) = 1.0 kΩ	1.0	—	—	µs	Sampling in 20 states
Analog input capacitance		—	—	6	pF	
Sample and hold circuit in use	Integral nonlinearity error	—	—	±6.0	LSB	AVin = 0.25 to AV_{REFH}–0.25
	Offset error	—	—	±6.0	LSB	
	Full-scale error	—	—	±6.0	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	—	±8.0	LSB	
Sample and hold circuit not in use	Integral nonlinearity error	—	—	±3.0	LSB	AVin = AV_{REFL} to AV_{REFH}
	Offset error	—	—	±3.0	LSB	
	Full-scale error	—	—	±3.0	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	—	±6.0	LSB	

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

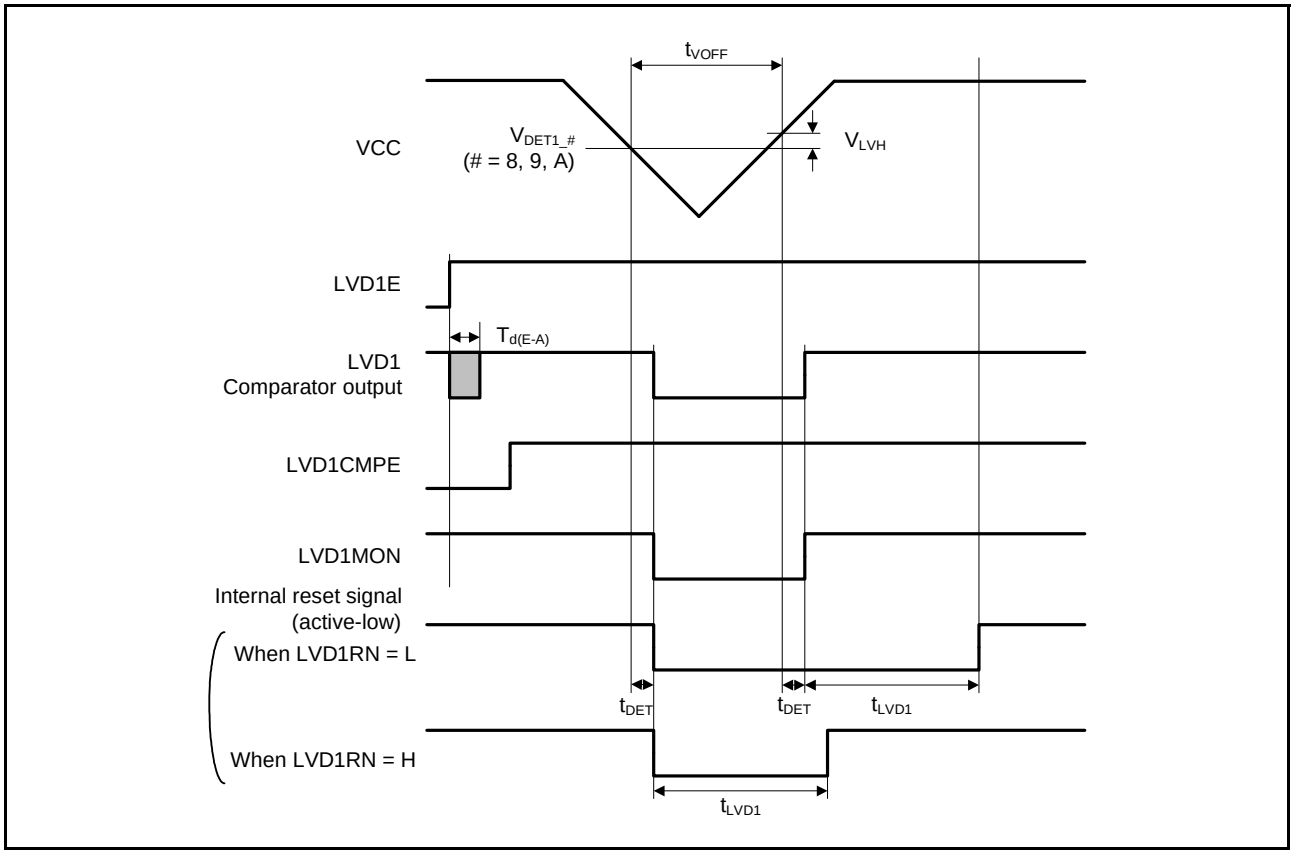


Figure 5.41 Voltage Detection Circuit Timing (V_{DET1})

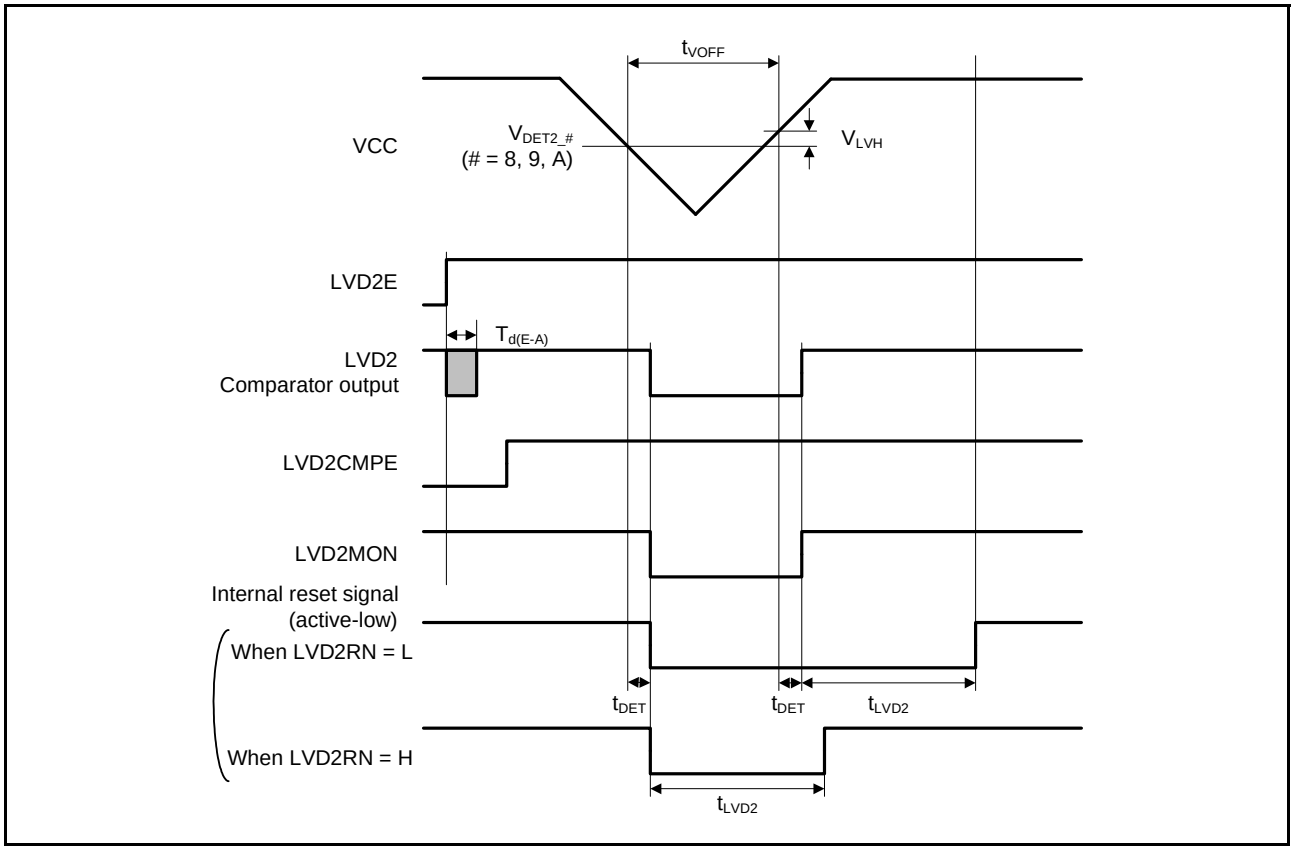


Figure 5.42 Voltage Detection Circuit Timing (V_{DET2})

6.2 DC Characteristics

Table 6.2 DC Characteristics (1)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	IRQ input pin MTU3 input pin POE3 input pin SCI input pin A/D trigger input pin GPT input pin RES#, NMI	V_{IH}	VCC × 0.8	—	VCC + 0.3	V	
		V_{IL}	–0.3	—	VCC × 0.2		
		ΔV_T	VCC × 0.06	—	—		
	RIIC input pin (IICBus operating)	V_{IH}	VCC × 0.7	—	5.8		
		V_{IL}	–0.3	—	VCC × 0.3		
		ΔV_T	VCC × 0.05	—	—		
	Port 4 (also used as an analog port)	V_{IH}	AVCC0 × 0.8	—	AVCC0 + 0.3		
		V_{IL}	–0.3	—	AVCC0×0.2		
	Ports for 5 V tolerant*1	V_{IH}	VCC × 0.8	—	5.8		
		V_{IL}	–0.3	—	VCC × 0.2		
Input high voltage (except for Schmitt trigger input pin)	MD pin, EMLE	V_{IH}	VCC × 0.9	—	VCC + 0.3		
	EXTAL, TCK, RSPI input pin		VCC × 0.8	—	VCC + 0.3		
	RIIC input pin (SMBus operating)		2.1	—	VCC + 0.3		
Input low voltage (except for Schmitt trigger input pin)	MD pin, EMLE	V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL, TCK, RSPI input pin		–0.3	—	VCC × 0.2		
	RIIC input pin (SMBus operating)		–0.3	—	0.8		
Output high voltage	All output pins	V_{OH}	VCC – 0.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins (except for RIIC pins)	V_{OL}	—	—	0.5	V	I_{OL} = 1.0 mA
	RIIC pins		—	—	0.4		I_{OL} = 3 mA
			—	—	0.6		I_{OL} = 6 mA
Input leakage current	RES#, MD pin, EMLE, Ports 4 and PE2	$\lvert I_{in} \rvert$	—	—	1.0	µA	V_{in} = 0V, V_{in} = VCC
Three-state leakage current (off state)	Ports for 5V tolerant	$\lvert I_{TSI} \rvert$	—	—	1.0	µA	V_{in} = 0V, V_{in} = 5.5 V
			—	—	5.0		
Input capacitance	All input pins (except for ports PB1 and PB2)	C_{in}	—	—	15	pF	V_{in} = 0V, f = 1 MHz, T_a = 25ºC
	Ports PB1 and PB2		—	—	30		

Note 1. Ports 0, 1, 2, 3, 7, 9, A, B, and D are 5 V tolerant.

Table 6.3 DC Characteristics (2)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Supply current*1	During operation	Max. *2	I_{CC}*3	—	—	60	mA	ICLK = 100MHz PCLKA = 100MHz PCLKB = 50MHz PCLKD = 50MHz FCLK = 50MHz
		Normal *4		—	25	—		
		Increased by BGO operation*5		—	15	—		
	Sleep mode				25	35		
	All-module-clock-stop mode*6				14	25		
	During standby	Software standby mode		—	0.2	6	mA	
		Deep software standby mode		—	16	40	µA	
Analog power supply current	During 12-bit A/D conversion (sample & hold circuit in use)		AI_{CC0}	—	3	4	mA	
	During 12-bit A/D conversion (sample & hold circuit not in use)			—	2	3	mA	
	Window comparator (1-channel operation)				0.4	1	mA	
	Window comparator (3-channel operation)			—	0.5	1	mA	
	Waiting for 12-bit AD conversion			—	25	32	µA	
Reference power supply current	During 12-bit A/D conversion		AI_{REFH0}	—	0.6	0.7	mA	
	Waiting for 12-bit A/D conversion			—	0.6	0.7	mA	
VCC rising gradient			SrVcc	—	—	20000	ms/V	

Note 1. Supply current values are with all output pins unloaded.
Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.
Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK: PCLK = 8:4)
ICC max = 0.45 × f + 15 (Max)
ICC typ = 0.18 × f + 7 (Normal)
ICC max = 0.22 × f + 13 (sleep mode)
Note 4. Measured with clocks not supplied to the peripheral functions. This does not include the BGO operation.
Note 5. Incremented if data is written to or erased from the on-chip ROM or on-chip data-flash memory for data storage during the program execution.
Note 6. The values are for reference.

Table 6.4 Permissible Output Currents

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item	Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	I_{OL}	—	—	2.0*1	mA
Permissible output low current (max. value per pin)	I_{OL}	—	—	4.0*1	mA
Permissible output low current (total)	ΣI_{OL}	—	—	32	mA
Permissible output high current (average value per pin)	$-I_{OH}$	—	—	2.0	mA
Permissible output high current (max. value per pin)	$-I_{OH}$	—	—	4.0	mA
Permissible output high current (total)	$\Sigma-I_{OH}$	—	—	32	mA

Caution: To protect the MCU's reliability, the output current values should not exceed the values in this table.
Note 1. RIIC pin: IOL = 6 mA (max.)

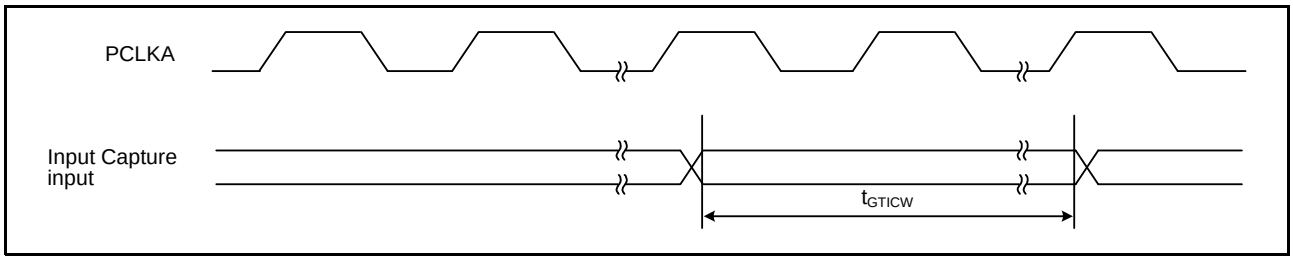


Figure 6.15 GPT Input/Output Timing

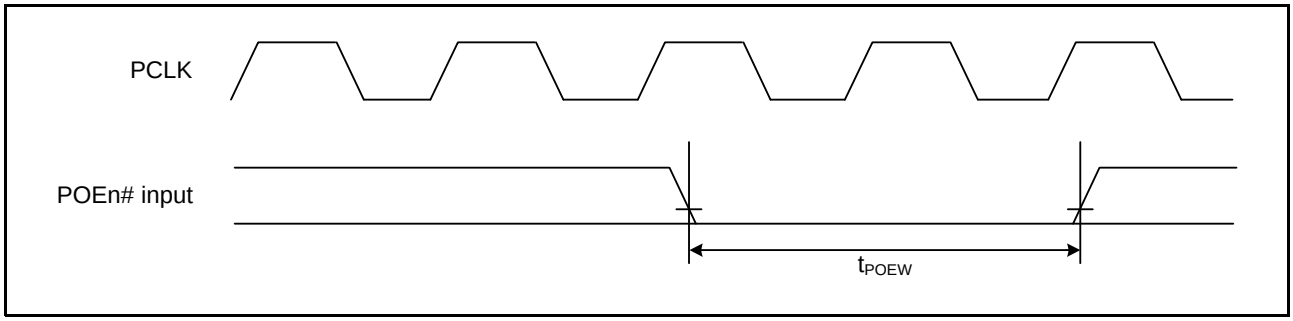


Figure 6.16 POE3# Input Timing

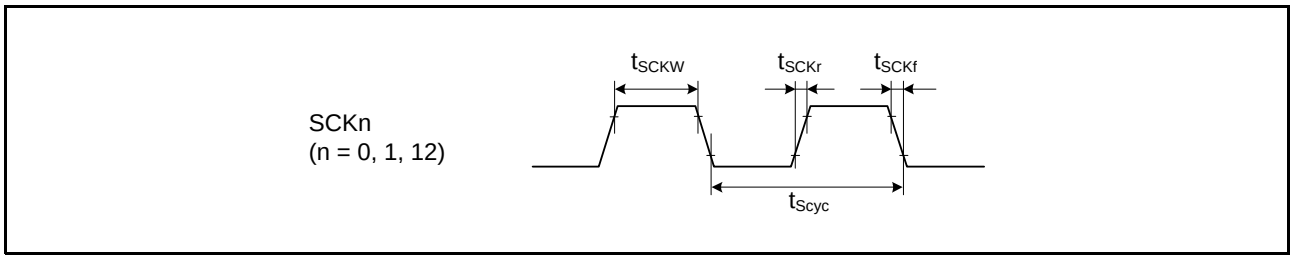


Figure 6.17 SCK Clock Input Timing

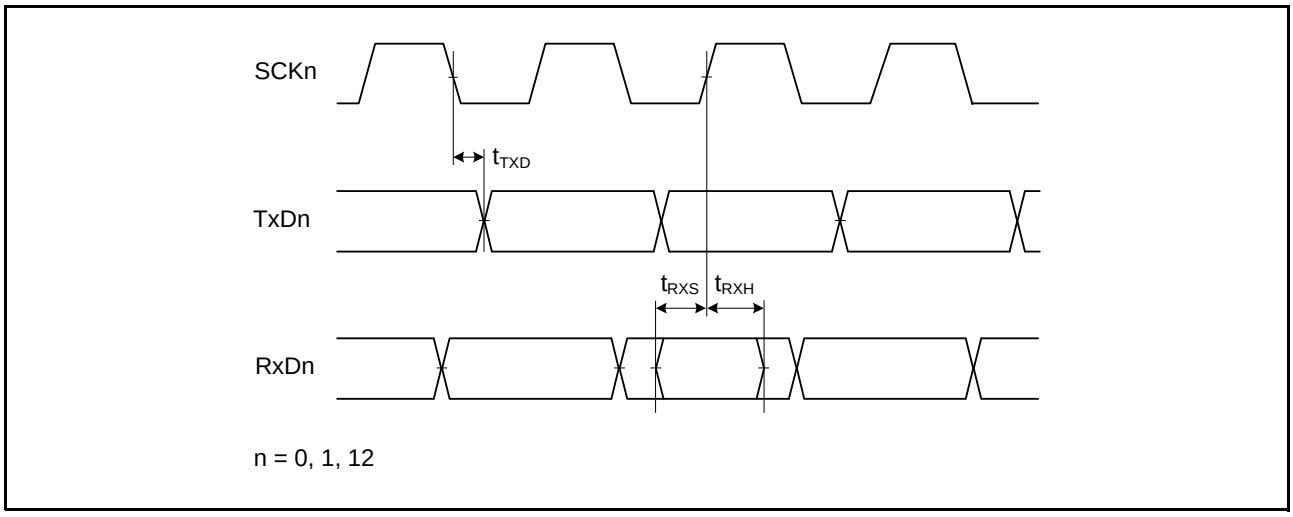


Figure 6.18 SCI Input/Output Timing: Clock Synchronous Mode

6.5 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Table 6.18 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V_{POR}	2.5	2.6	2.7	V	Figure 6.26
	Voltage detection circuit (LVD0)	V_{DET0}	2.7	2.8	2.9		Figure 6.27
	Voltage detection circuit (LVD1)	V_{DET1}	2.80	2.95	3.10		
	Voltage detection circuit (LVD2)	V_{DET2}	2.80	2.95	3.10		
Internal reset time	Power-on reset (POR)	t_{POR}	—	4.6		ms	Figure 6.26
	Voltage detection circuit (LVD0)	t_{LVD0}	—	4.6			Figure 6.27
	Voltage detection circuit (LVD1)	t_{LVD1}	—	0.9			Figure 6.28
	Voltage detection circuit (LVD2)	t_{LVD2}	—	0.9			Figure 6.29
Minimum VCC down time*1		t_{VOFF}	200	—	—	µs	Figure 6.26, Figure 6.27
Response delay time		t_{det}			200	µs	Figure 6.26 to Figure 6.29
LVD operation stabilization time (after LVD is enabled)		$Td_{(E-A)}$			3	µs	Figure 6.28 Figure 6.29
Hysteresis width (LVD1 and LVD2)		V_{LVH}		80		mV	

Note 1. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{DET1}, and V_{DET2} for the POR/ LVD.

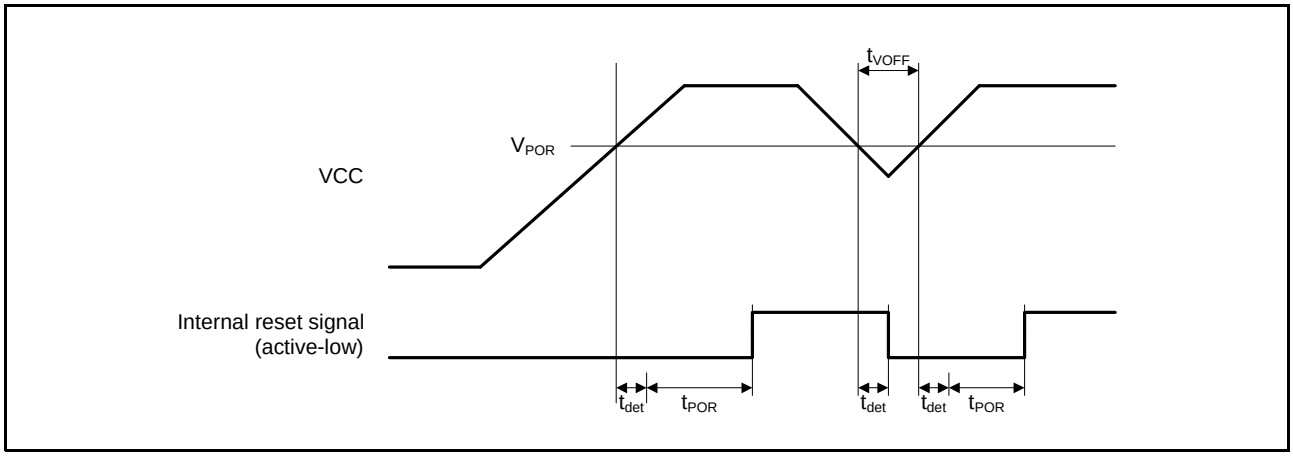


Figure 6.26 Power-on Reset Timing

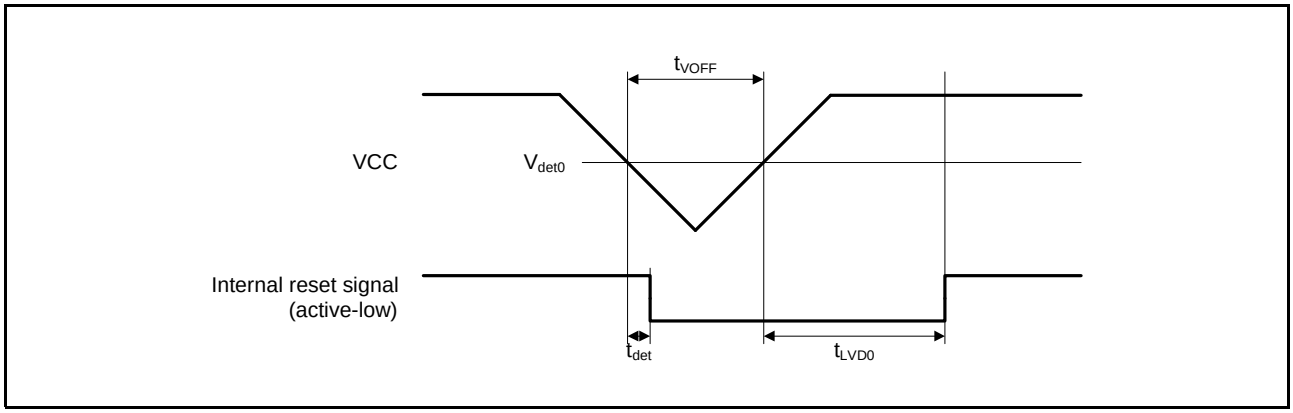


Figure 6.27 Voltage Detection Circuit Timing (V_{det0})

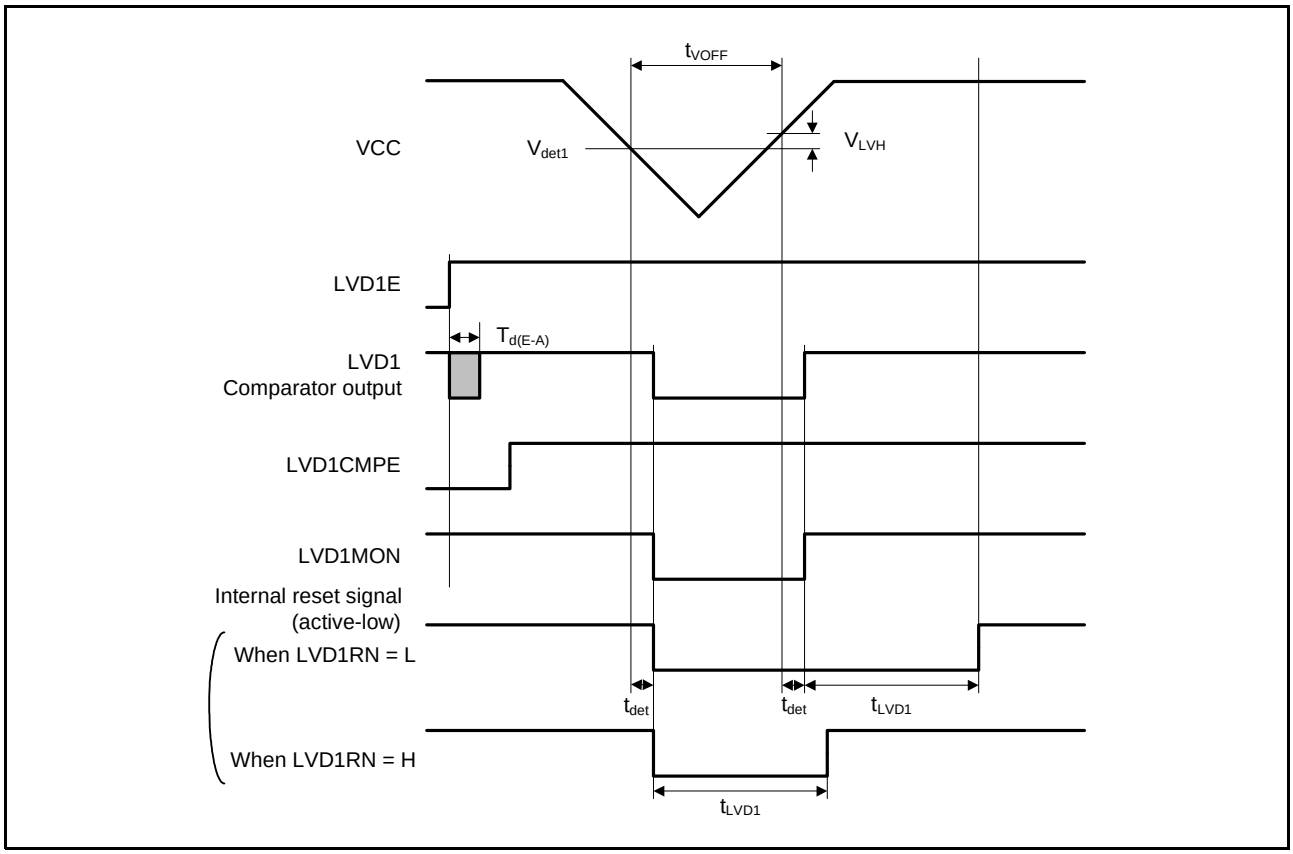


Figure 6.28 Voltage Detection Circuit Timing (V_{det1})

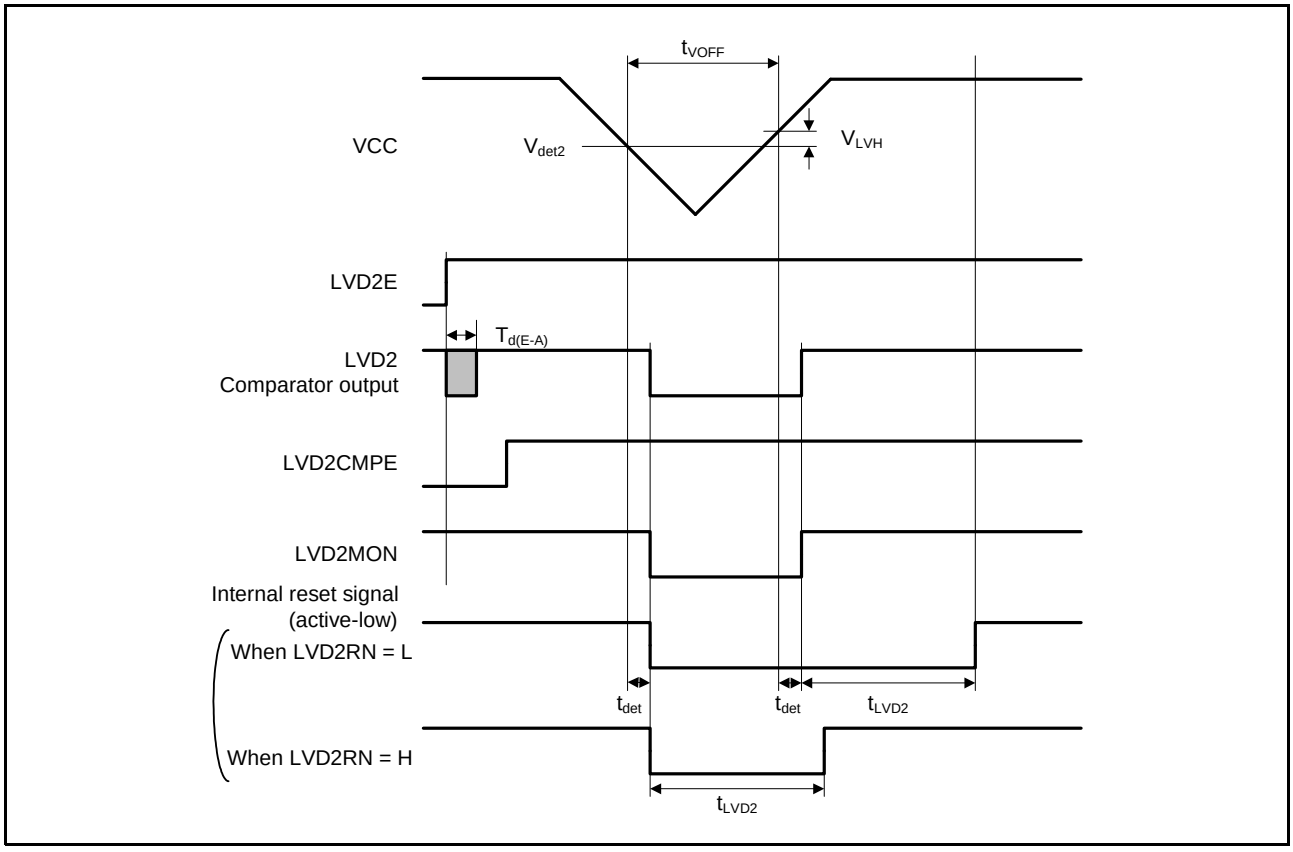


Figure 6.29 Voltage Detection Circuit Timing (V_{det2})

6.8 E^2 DataFlash Characteristic

Table 6.22 E^2 DataFlash (Flash Memory for Data Storage) Characteristics (1)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0
Temperature range for the programming/erasure operation: $T_a = T_{opr}$. T_a is common to conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Reprogram/erase cycle*1	N_{DPEC}	100000	—	—	Times	
Data hold time	t_{DDRP}	30*2	—	—	Year	Ta = +85°C

Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 128-byte programming is performed 16 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. The value is obtained from the reliability test.

Table 6.23 E^2 DataFlash (Flash Memory for Data Storage) Characteristics (2)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	min	typ	max	Unit	Test Condition
Programming time	2 bytes	t_{DP2}	—	0.25	2	ms	FCLK = 50 MHz
Erasure time	32 bytes	t_{DE32}	—	2	20	ms	FCLK = 50 MHz $N_{DPEC} \leq 100$
	32 bytes	t_{DE32}	—	4	20	ms	FCLK = 50 MHz $N_{DPEC} > 100$
Blank check time	2 bytes	t_{DBC2}	—	—	30	µs	FCLK = 50 MHz
Suspend delay time during programming		t_{DSPD}	—	—	120	µs	Figure 6.31 PCLKB = 50 MHz
First suspend delay time during erasing (in suspend priority mode)		t_{DSESD1}	—	—	120	µs	
Second suspend delay time during erasing (in suspend priority mode)		t_{DSESD2}	—	—	300	µs	
Suspend delay time during erasing (in erasure priority mode)		t_{DSEED}	—	—	300	µs	